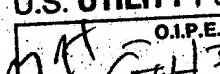


65/137/01

		Subclass	ISSUE CLASSIFICATION			PATENT NUMBER	
U.S. UTILITY Patent Application							
 O.I.P.E. GH3 SCANNED			PATENT DATE				
			0.A. 003				
APPLICATION NO. 09/883216	CONT/PRIOR	CLASS 257	SUBCLASS 2	ART UNIT 2811	EXAMINER PARK		
APPLICANTS Jen Fang Ching Chiang Shih Chen Chau Wang	BEST AVAILABLE COPY						
Semiconductor device having bump electrodes							
TITLE							
PTO-2040 12/89							

TERMINAL DISCLAIMER	DRAWINGS			CLAIMS ALLOWED	
	Sheets Drwg.	Figs. Drwg.	Print Fig.	Total Claims	Print Claim for O.G.
<input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed.	(Assistant Examiner) _____ (Date) _____			NOTICE OF ALLOWANCE MAILED	
<input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S Patent. No. _____ _____ _____	(Primary Examiner) _____ (Date) _____				
<input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.	(Legal Instruments Examiner) _____ (Date) _____			ISSUE FEE	
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